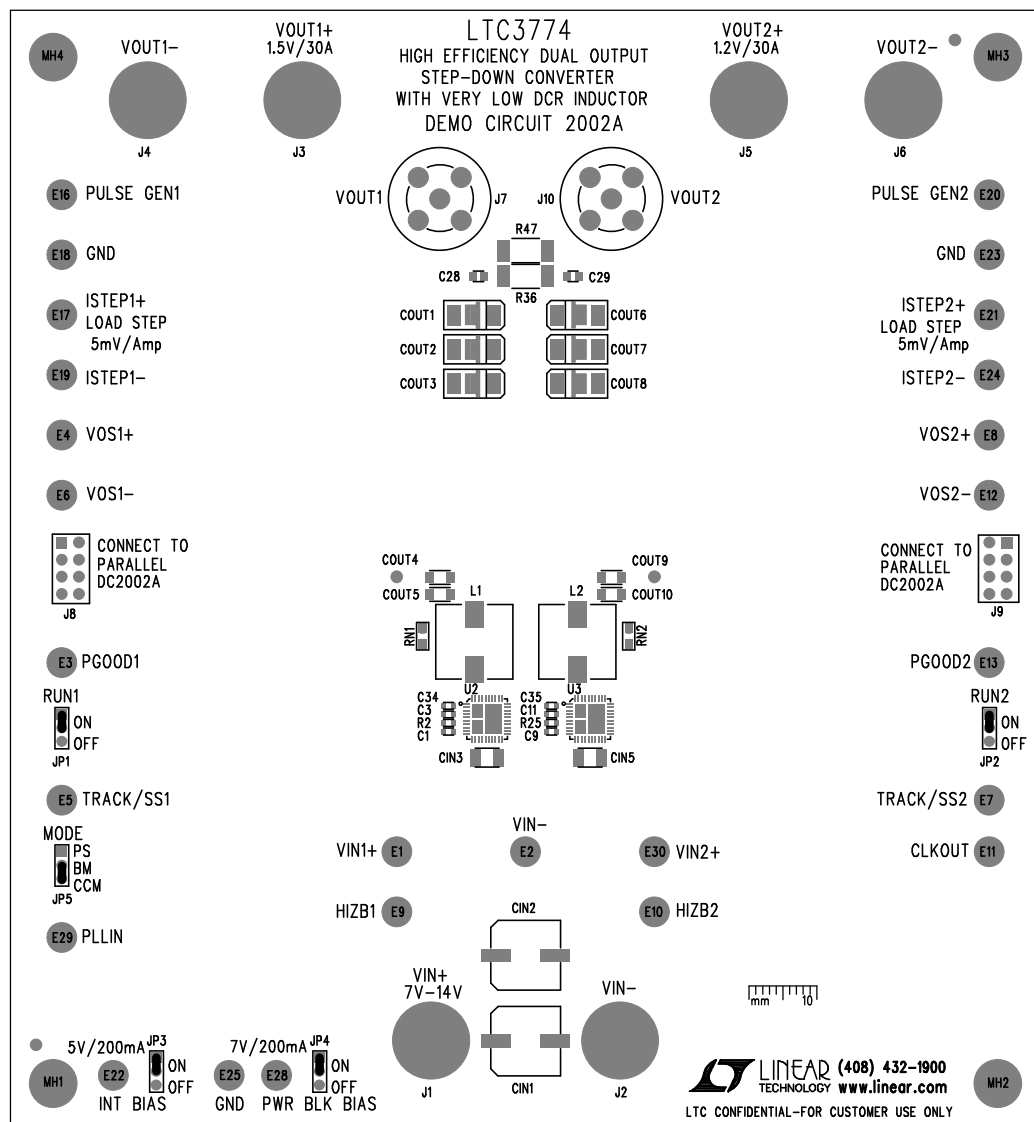
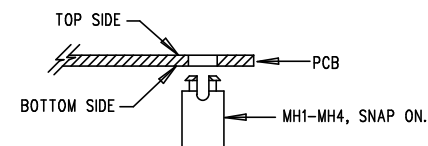



REVISION HISTORY				
ECO	REV	DESCRIPTION	APP. ENG.	DATE
-	2	PRODUCTION	MIKE S.	6-04-13



NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD.
MAXIMUM SOLDER TEMPERATURE IS 240 DEGREES CELSIUS.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS.
LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER.
MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE
BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP
TO ANY BOARD.
7. INSTALL 4 STANDOFFS AT LOCATIONS AS SHOWN BELOW:



APPROVALS		 <div style="float: right; text-align: right;">1630 MCCARTHY BLVD MILPITAS, CA 95035 PH: (408) 432-1800 www.linear.com LTC CONFIDENTIAL- FOR CUSTOMER USE ONLY</div>			
PCB DES.	LT				
APP ENG.	MIKE S.	TITLE: TOP ASSEMBLY DRAWING HIGH EFFICIENCY DUAL OUTPUT STEP-DOWN CONVERTER WITH VERY LOW DCR INDUCTOR			
		SIZE	IC NO.	LTC3774EUHE	REV.
		N/A	DEMO CIRCUIT 2002A		2
SCALE = NONE		FILENAME: DC2002A-2.PCB			SHT 1 OF 2